

Corrosion and Corrosion Protection of Copper Sculptures by Formation of Composite Barrier

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ABSTRACT

Nitrogen dioxide, carbon dioxide and sulphur dioxide are acidic gas and they produce corrosive medium for copper sculptures. These gases absorb moisture to form nitric acid, carbonic and sulphuric acid. It forms corrosion cell on the surface of copper and accelerate corrosion reactions. The corrosion cell formation is written as: $\text{Cu}|\text{Cu}^{2+}||\text{H}^+|\text{H}_2$ thus corrosion reactions start and copper is oxidized into Cu^{2+} surface and it is oxidized into Cu^{2+} whereas H^+ ion is reduced into H_2 . Nitric acid environment copper exhibits galvanic, pitting, stress, crevice, blistering, embrittlement and intergranular corrosion. The corrosion reactions change physical, chemical and mechanical properties of corroded materials. Nanocoating compound tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC electro spray compounds used to control the corrosion of copper in nitrogen dioxide medium. For corrosion mitigation of copper metal interface was coated with tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC. The coating compound tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone was synthesized in laboratory. Nozzle spray techniques used for nanocoating and electro spraying. The corrosion rate of copper was determined by gravimetric loss method at different temperatures, concentrations and days in nitrogen dioxide medium. Potentiostatic polarization technique used for the determination of electrode potential, corrosion current and current density. Nanocoating and electro spraying compounds formed a composite barrier on the surface of base metal by chemical bonding. The nanocoating and electro spray compounds adhered on base metal by chemisorptions to confirm by activation energy, heat of adsorption, free energy, enthalpy and entropy. The nanocoating and electro spray deposited on copper confirmed by Langmuir, Frundlich and Temkin isotherm. Copper formed a complex compound to interact with tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC. Electro spraying SiC blocked porosities of nanocoating compound and checked osmosis process of nitrogen dioxide. Thenanocoating and electro spray compounds decreased corrosion rate and increased surface coverage areas and percentage coating efficiencies.

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Introduction

Copper metal uses for construction of sculptures, monuments and other items. Nitrogen dioxide develops corrosive medium copper appliances. Developed Nations expense 5% of GNP for corrosion protection materials. The acidic oxides of sulphur, carbon and nitrogen produce hostile environment of metals. These gases corrosive nature depend upon air quality of village, city and industry areas. Particulate matters produce hostile environment for metals. Acids, bases and salts create ambient environment for materials [1-8]. The Cl⁻ ions concentration in marine environment is high so it generates corrosive medium for building components. The corrosion of metals depends upon their surrounding conditions like dry and wet weather, low and high temperature, moisture and humidity, nature of water, concentration of oxygen, composition of pollutants and effluents. The other factors aggravate corrosion

materials like season change, weather change, greenhouse gases, global warming, and climate change to exhibit various forms of corrosion. Solar radiation and heat produce destruction in materials. Crude oil well contains CO₂ and SO₂ to generate hostile environment for metals. Biowastes develop micro and macroorganisms to cause of biological corrosion [9-19]. The disturbance of internal morphology of metals is responsible for corrosion. Several corrosion protection techniques are used for safe materials above ambient conditions. Some Protective methods are applied metallic coating deposition of metal and nonmetal coating which is related to electroplating, flame spraying, cladding, hot dipping and vapour deposition process. Polymeric coating protects interface of metals by paint coating and lamination of thermoplastic and thermoset plastic. Organic and inorganic inhibitors suppress the corrosion of metal as per nature of surrounding environment. Organic inhibitors provide protection as anodic, cathodic and mixed inhibitors. Nanocoatings coating forms strong bonding between base metals and coating compounds but surface porosities

don't protect base metals long period. These porosities block by electrospray technique. The nanocoating and electrospray substances form composite barrier which stop osmosis or diffusion process corrosive matters. The composite barrier is passive in nature which save materials for attack of corrosive substances and enhance physical, chemical and mechanical properties of materials [20-24].

Experimental

The gravimetric, potentiostat, nanocoating and electrospray techniques used for experimental work. The nanocoating compound tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone was synthesized in laboratory.

Gravimetric Technique

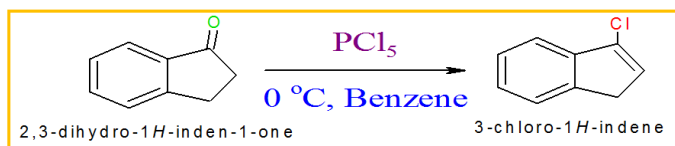
The test samples of copper metal cut into size of (2X4X0.1) sq cm and all samples washed distilled water thus dust can be removed. The samples surface was cleaned by emery paper then after erasing with acetone. The samples were dried with hot air gun and kept into desiccators for further experiment. The copper samples dipped into 10 ml nitric acid solution and corrosion rate of uncoated and coated sample determined at 283, 293, 303, 313 and 323 K temperatures and time mentioned 10, 20, 30, 40, 50 days. The samples coated with 50 mM of tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and 20 mM of SiC. The organic compound tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC formed a thin composite barrier. Nozzle spray used coating for the covering the surface. The nanocoating and electrospray compound bonded with base metal through chemical bonding to observe by values of activation energy, heat of adsorption, free energy, enthalpy and entropy.

Potentiostat

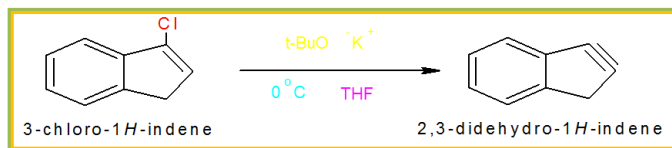
Potentiostat 173 model was used for calculation of corrosion potential, corrosion current and corrosion current density. First make an electrode of copper which kept between calomel electrode and Pt electrode. The uncoated and coated sample corrosion potential, corrosion current and corrosion current density results were calculated. The sample coated with tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC in 10 mM HNO₃ solution.

Synthesis Of Tetrahydro-Dibenzo[a,d][7]Annulene-5,11-Disemicarbazone

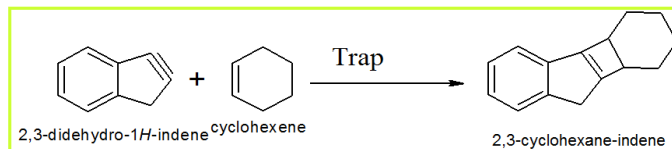
Phosphorus pentachloride dissolved in benzene that solution added into 2,3-dihydro-1H-indene-1-one at 0°C temperature to yield 3-chloro-1H-indene.



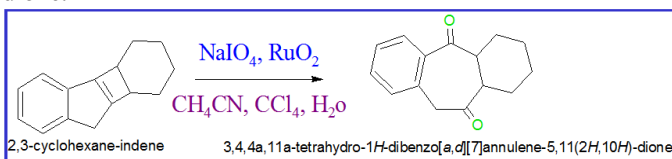
Potassium t-butoxide mixed into 3-Chloro-1H-indene solution at 0°C temperature to give 2,3-cyclohexene-indene.



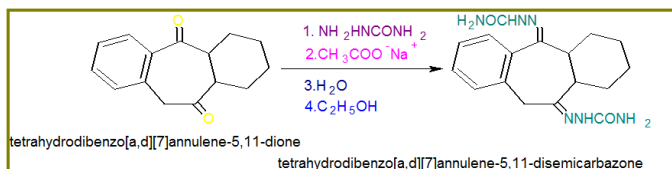
The compound 2,3-didehydro-1H-indene trapped cyclohexene to produce 2,3-cyclohexene-indene.



The compound 2,3-cyclohexene-indene oxidized with NaIO₄ in presence of RuO₂ in solution of methyl nitrile and carbon tetrachloride to yield tetrahydro-dibenzo[a,d][7]annulene-5,11-dione.



The solution semicarbazide added into tetrahydro-dibenzo[a,d][7]annulene-5,11-dione in presence of sodium acetate, HCl and ethyl alcohol to reflux the reaction mixture for 1 hour to yield tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone.



Results and Discussion

The corrosion rate of metal was calculated by equation $K = 13.56 \frac{W}{D A t}$, (where w is weight loss, D is density, A is surface area and t is immersion time). The copper metal was coated with tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC and its corrosion at different interval of 10, 20, 30, 40 and 50 days recorded in Table 1. The results of Table 1 were shown that uncoated copper increased as immersion time enhanced but these reduced with coating and electrospray compounds. Such trends clearly noticed in Figure 1 which plotted between K (corrosion rate) versus t (day).

Table 1: Corrosion rate of uncoated and coated copper in 10 mM HNO₃

C & E	Temp(K)	283K	293K	303K	313K	323K	C (mM)
	Time(days)	10	20	30	40	50	
NC(0)	K ₀	205.305	255.974	273.798	292.062	304.671	00
	logK ₀	2.312	2.408	2.437	2.465	2.483	
C(1)	K	29.615	37.750	41.492	42.748	47.293	50
	logK	1.471	1.576	1.617	1.631	1.674	
	log(K/T)	0.923	1.044	1.099	1.127	1.184	
	θ	0.8557	0.8525	0.8484	0.8536	0.8447	
	(1-θ)	0.1443	0.1475	0.1516	0.1464	0.1553	
	log(θ/1-θ)	0.773	0.762	0.747	0.765	0.735	
	%CE	85.57	85.25	84.84	85.36	84.47	
SiC	K	23.085	26.207	28.737	30.002	34.576	20
	logK	1.363	1.418	1.458	1.477	1.538	
	log(K/T)	0.815	0.885	0.939	0.973	1.048	
	θ	0.8875	0.8976	0.8951	0.8972	0.8865	
	(1-θ)	0.1125	0.1024	0.1049	0.1028	0.1135	
	log(θ/1-θ)	0.897	0.942	0.931	0.941	0.892	
	%CE	88.75	89.76	89.51	89.72	88.65	

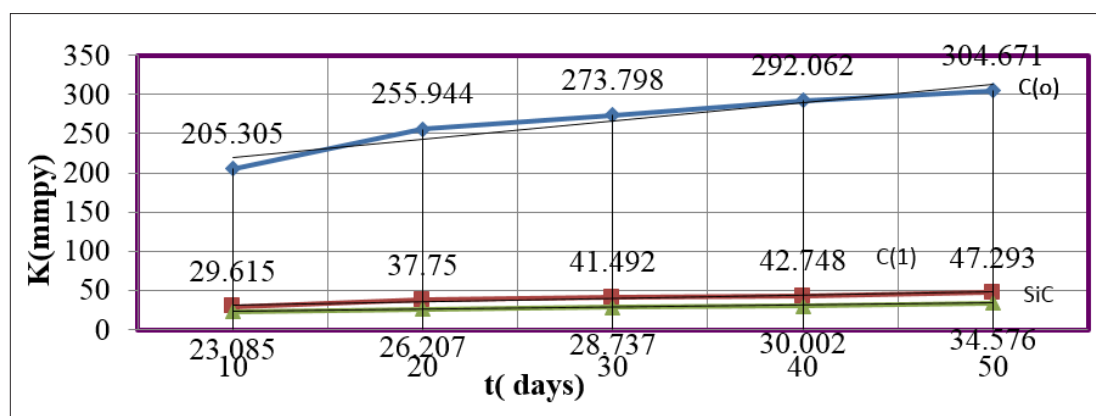


Figure 1: K Vs t for copper nanocoating with C(1) & SiC

C(0) = Uncoated

C(1) = tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone]

The corrosion rate of uncoated and coated copper was calculated at 283, 293, 303, 313 and 323 K temperatures and their values were mentioned in Table1. The uncoated copper metal corrosion rate found to be high but its values reduced coating with tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC. The corrosion rate of uncoated and coated copper variation with temperatures mentioned Table1. It observed that tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC decreased corrosion rate as temperature rising 283 to 323 K. Figure2 plotted between logK versus 1/T found to be straight and this graph satisfied Arrhenius equation.

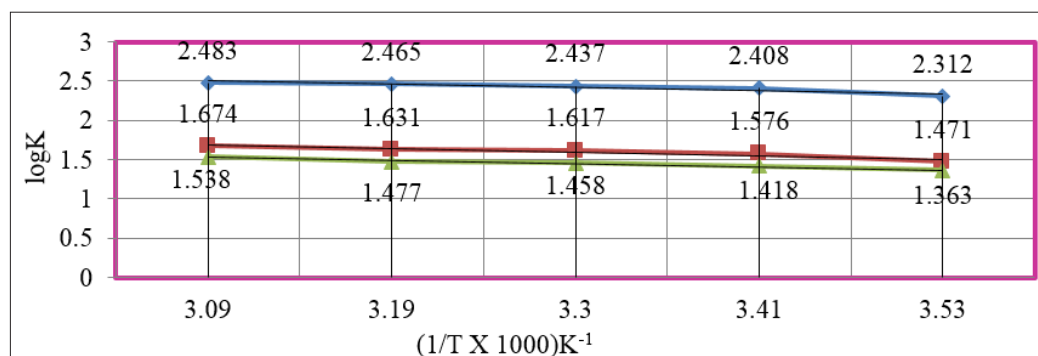


Figure 2: logK Vs 1/T for copper nanocoating with C(1) & SiC

Copper coated with tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC at 283, 293, 303, 313 and 323 K temperatures and the values $\log(\theta/1-\theta)$ obtained by Figure 3 which plotted between $\log(\theta/1-\theta)$ versus $1/T$. The results of $\log(\theta/1-\theta)$ with nanocoating and electrospray were given in Table1. The values of $\log(\theta/1-\theta)$ decreased with tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone but its values enhanced with SiC.

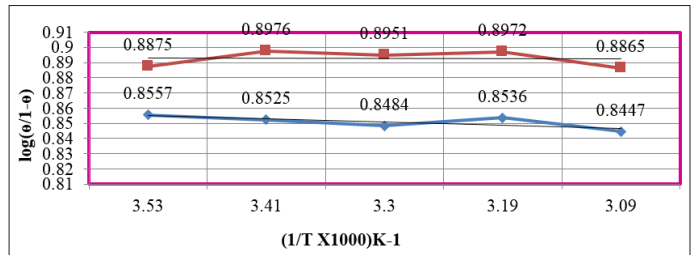


Figure 3: $\log(\theta/1-\theta)$ Vs $1/T$ for copper C(1) & SiC

The surface coverage area developed by tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC to calculate by equation $\theta = (K_o - K_o/K)$ at 283, 293, 303, 313 and 323 K temperatures and their values were recorded in Table1. It noticed that nanocoating tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone occupied lesser surface with respect of SiC . It clearly noticed in Figure4 plotted between θ (surface area) versus T (temperature).

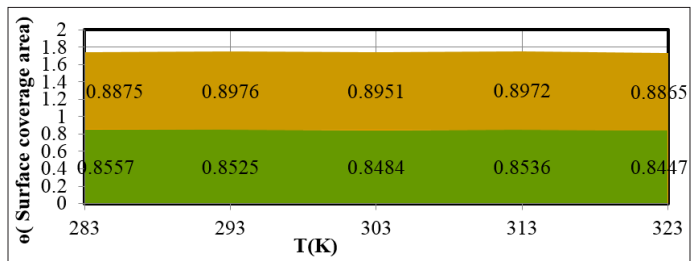


Figure 4: θ Vs T for copper coating with nanocoating of C(1) & SiC

The percentage coating efficiency of tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC were determined by equation $CE = (K_o - K_o/K) \times 100$ at 283, 293, 303, 313 and 323K temperatures and their values were given in Table1. Figure5 depicted SiC produced higher coating efficiencies with respect of tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone as shown in graph % CE (percentage coating efficiency) versus T (temperature)

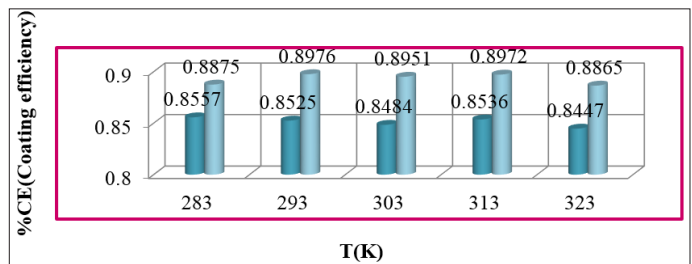


Figure 5: %CE Vs T for copper with nanocoating of C(1) & SiC

Arrhenius equation $d/dt(\log K) = A e^{-E_a/RT}$ used and Figure 2 for calculation of activation energy of uncoated and coated copper with tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC and their values were written Table 2. Activation energy found to be higher with uncoated copper but their values reduced

with nanocoating and electro spraying compounds. Activation energies values indicated nanocoating and electro spray compounds formed chemical bond with copper metal. The activation energy results of Table 2 indicated that activation energy nanocoating and electro spray reduced and surface coverage area increased as shown Figure 6.

Table 2: Thermal parameters values of tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC

Thermal Parameters	283K	293K	303K	313K	323K
$E_a(0)$	156.126	157.081	153.845	150.425	146.774
$E_a, C(1)$	99.335	102.807	102.079	99.531	98.952
$q, C(1)$	-52.119	-49.707	-47.157	-46.683	-43.447
$\Delta G, C(1)$	-202.178	-202.181	-198.251	-192.432	-188.994
$\Delta H, C(1)$	-62.413	-68.114	-69.407	-68.782	-70.037
$\Delta S, C(1)$	-74.954	-79.265	-81.108	-81.885	-83.828
$\theta, C(1)$	0.8557	0.8525	0.8484	0.8536	0.8447
E_a, SiC	92.041	92.501	92.042	90.133	90.913
q, SiC	-60.573	-61.449	-58.773	-57.424	-52.727
$\Delta G, SiC$	-194.873	-191.842	-188.180	-183.049	-180.953
$\Delta H, SiC$	-55.073	-57.774	-59.336	-59.398	-61.997
$\Delta S, SiC$	-70.806	-73.201	-75.004	-76.002	-78.624
θ, SiC	0.8875	0.8976	0.8972	0.8972	0.8865

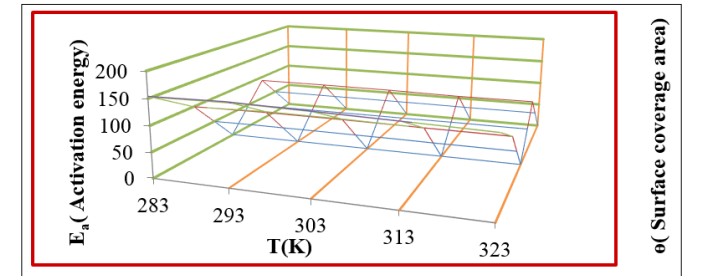


Figure 6: E_a Vs T, θ for copper with nanocoating of C(1) & SiC

Heat of adsorption determined by Langmuir isotherm $\log(\theta/1-\theta) = \log(A.C) - (q/2.303RT)$ for copper coating of tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC at 283, 293, 303, 313 and 323 K temperatures. Heat of adsorption recorded in Table2 and its values were show that heat of adsorption reduced and surface coverage increased as shown in Figure7 which plotted q (heat of adsorption) versus T(temperature) and θ (surface coverage area). The negative values of heat of adsorption indicated that nanocoating and electro spray compound bonded with copper metal by chemical bonding.

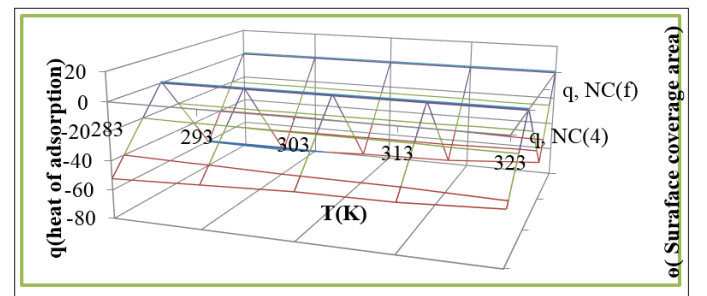


Figure 7: q Vs T, θ for copper with nanocoating C(1) & SiC

Free energy of tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC obtained by equation $\Delta G = -2.303 RT \log(33.3K)$ and their values were given in Table 2. The results of Table 2 exhibited that nanocoating and electrospray formed composite barrier by chemical bonding. Figure 8 depicted that free energy decreased as temperatures rising whereas surface coverage area enhanced such results observed in Figure 8. Exothermic process occurred during nanocoating and electrospraying of tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC.

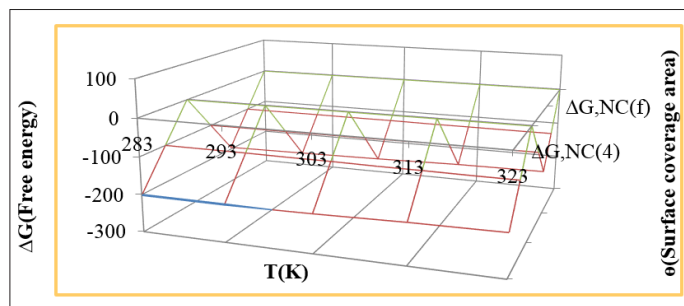


Figure 8: ΔG Vs T, θ for copper with nanocoating of C(1) & SiC

Enthalpy of tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC was calculated by transition state equation $K = R T / N h \log (\Delta S \# / R) X \log (-\Delta H \# / R T)$ and Figure 9 plotted between $\log(K/T)$ versus $1/T$ and their values were mentioned in Table 2. Enthalpy of nanocoating and electrospray decreased and surface coverage area increased as shown in Figure 10. Enthalpy values found to be negative which indicated that nanocoating and electrospraying an exothermic process. Both compounds adhered on the base metal by chemical bonding.

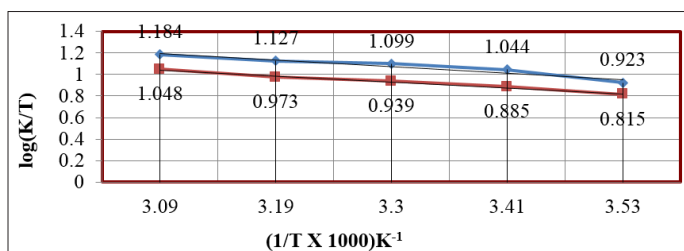


Figure 9: $\log(K/T)$ Vs $1/T$ for copper with nanocoating of C(1) & SiC

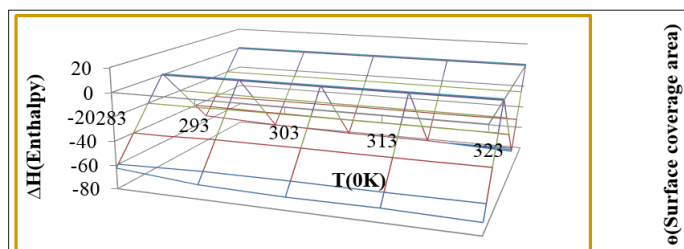


Figure 10: ΔH Vs T, θ for copper with nanocoating of C(1) & SiC

Entropy of tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC was determined at various temperatures by above mentioned transition state equation and their values were written in Table 2. The results of entropy indicated that both compounds arranged on base material in ordered manners with chemical bonding. Figure 11 plotted between ΔS (entropy) versus T , and θ for nanocoating and electrospraying materials.

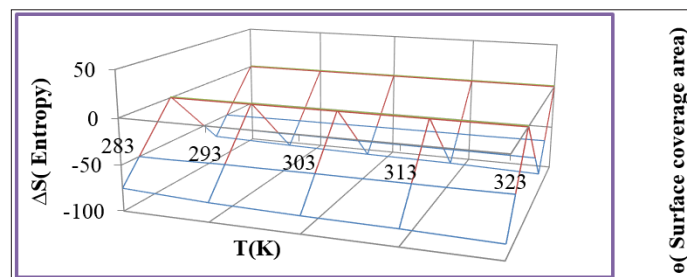


Figure 11: ΔS Vs T, θ for copper with nanocoating of C(1) & SiC

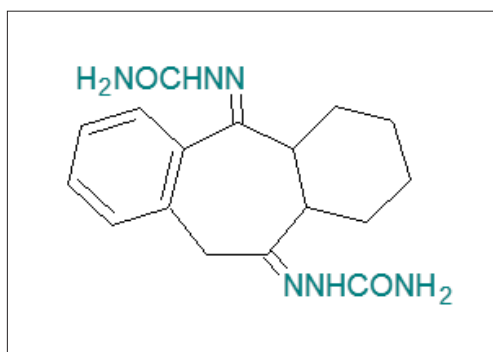
Electrode potential and corrosion current density of aluminum, tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC were determined by equation $\Delta E/\Delta I = \beta_a \beta_c / 2.303 I (\beta_a + \beta_c)$ and Tafel graph of Figure 12 plotted between ΔE (electrode potential) versus I (corrosion current density). The results of electrode potential and corrosion current density were written in Table 3. The results of Table 3 saw that electrode potential and corrosion current density increased with uncoated aluminum but these values were reduced by nanocoating and electrospraying materials. Anodic current enhanced and cathodic current reduced with uncoated aluminum aluminium. But it coated with tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC anodic current decreased and cathodic current increased.

Corrosion current of aluminum, tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC was determined by above equation and their values were put in equation $CR (mmpy) = 0.1288 I (mA/cm^2) \times Eq. Wt (g) / \rho (g/cm^3)$ to obtain corrosion rate of uncoated and coated aluminum and their values mentioned in Table 3. It noticed that corrosion rate of uncoated aluminum found to high but coated aluminum corrosion rates were low. Both materials enhanced surface coverage area and coating efficiency. The results of corrosion rate of aluminum obtained by potentiostat technique confirmed by weight loss experiment.

Table 3: Potentiostat polarization of copper of tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and electrospaying SiC.

NC	ΔE (mV)	ΔI	β_a	β_c	I_{corr} (mA/cm ²)	K (mmpy)	θ	%CE	C (mM)
C(0)	-630	239	286	126	14.43	620.533	00	00	00
C(1)	-172	39	21	203	1.87	80.410	0.8704	87.04	30
SiC	-158	31	18	207	1.41	60.630	0.9022	90.22	10

Tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone is an electronic rich organic compound. It possesses several electron donor functional groups so it forms thin film barrier on copper metal. This coating compound develops lots of porosities on the interface of base metal. The H_3O^+ ions enter inside through osmosis due to porosities form by Tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone. These ions accelerate corrosion reaction so SiC uses as electrospaying which blocked porosities and protect metal. The nanocoating compound tetrahydro-dibenzo [a,d] [7] annulene-5,11-disemicarbazone and SiC form composite thin film barrier that is work as passive barrier against corrosive medium.



Conclusion

The nanocoating compound tetrahydro-dibenzo[a,d][7]annulene-5,11-disemicarbazone and SiC coated on the surface copper metal and its corrosion phenomena studied in nitrogen dioxide environment. The corrosion rate of uncoated and coated copper was determined at different temperatures in nitrogen dioxide environment. Nanocoating and electro spray compounds formed composite thin film barrier with metal. The composite compound decreased corrosion and enhanced surface coverage area and coating efficiency. The results of activation energy, heat of adsorption, free energy, enthalpy and entropy indicated that composite barrier formed by chemisorptions process. The adsorption phenomena of these compounds confirmed by Langmuir, Freundlich and Temkin adsorption isotherms. The composite compounds increased coating efficiency and percentage coverage areas and neutralized the attack of nitrogen dioxide.

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